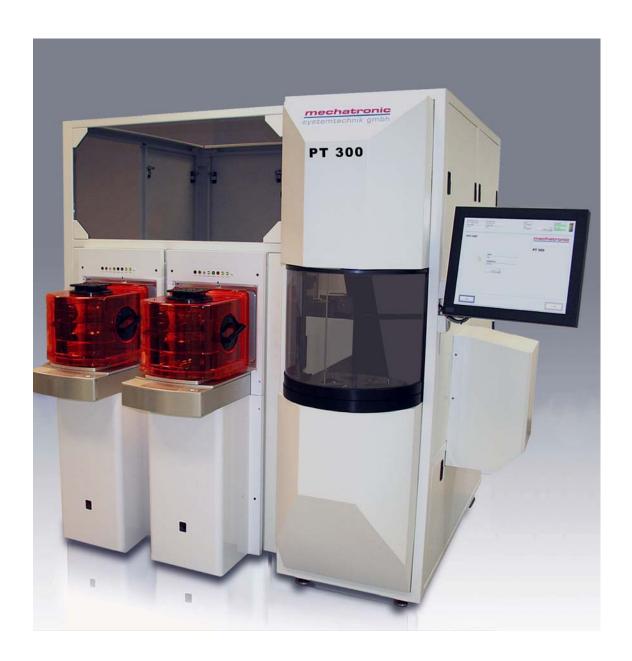


ThinWafer Packing Tool PT 300











Brand new:

- 400 wafers per hour (minimum)
- 65% less operator area needed
- Saves 72% on cleanroom space
- Outstanding "throughput/footprint ratio"

Specifications:

- Packing of 300 mm wafers
- > 50 µm
- Cleanroom class 10

Hard facts:

- 400 w/h throughput minimum The packing process runs at a minimum of 400 wafers per hour, because of the redesigned arrangement of the material boxes.
- 65% less operator area The PT 300 is operated and loaded only from the front.
- Saves 72% on cleanroom space
 As the PT 300 is operated from the front this allows you to place only the front of the tool in the cleanroom saving 72% on cleanroom space.
 Complete service area outside the cleanroom possible!
- Outstanding "throughput/footprint ratio"
 On one square meter we process
 133 wafers per hour.